



PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Ideally Suited for Automated Insertion
- Complementary NPN Types Available (BC846W-BC848W)
- For Switching and AF Amplifier Applications
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Pin Connections: See Diagram
- Marking Code: See Table Below & Diagram on Page 3
- Ordering & Date Code Information: See Page 3
- Weight: 0.006 grams (approximate)

Marking Code (Note 2)										
Type Marking Type Marking										
BC856AW	K3A	BC857CW	K3G							
BC856BW	K3B	BC858AW	K3J, K3A, K3V							
BC857AW	K3V, K3A	BC858BW	K3K, K3B, K3W							
BC857BW	K3W, K3B	BC858CW	K3L, K3G							

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit		
Collector-Base Voltage	BC856	.	-80			
	BC857	V _{CBO}	-50	V		
	BC858		-30			
Collector-Emitter Voltage	BC856		-65			
	BC857	V _{CEO}	-45	V		
	BC858		-30			
Emitter-Base Voltage		V _{EBO}	-5.0	V		
Collector Current		lc	-100	mA		
Peak Collector Current		ICM	-200	mA		
Peak Emitter Current		I _{EM}	-200	mA		
Power Dissipation (Note 1)		Pd	200	mW		
Thermal Resistance, Junction to Ambie	nt (Note 1)	$R_{ ext{ heta}JA}$	625	°C/W		
Operating and Storage Temperature Ra	ange	T _j , T _{STG}	-65 to +150	°C		

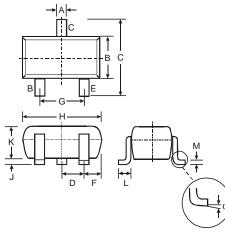
Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

2. Current gain subgroup "C" is not available for BC856W.

3. No purposefully added lead.

4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

 Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



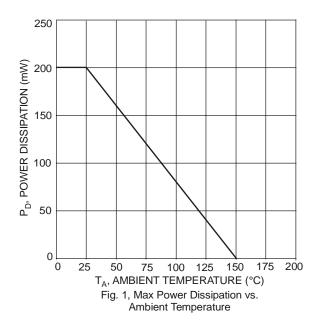
	SOT-323									
Dim	Min	Max								
Α	0.25	0.40								
В	1.15	1.35								
С	2.00	2.20								
D	0.65 Nominal									
Е	0.30	0.40								
G	1.20	1.40								
Н	1.80	2.20								
J	0.0 0.10									
К	0.90	1.00								
L	0.25	0.40								
М	0.10	0.18								
α	0°	8°								
All Din	nensions	in mm								

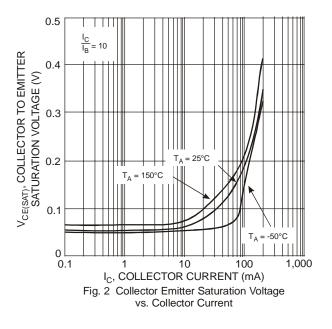


Electrical Characteristics @T_A = 25°C unless otherwise specified

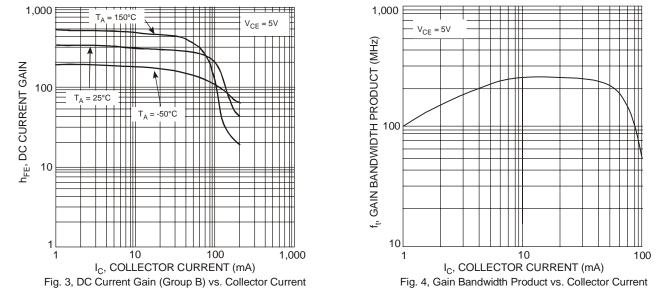
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage (Note 6)	BC856 BC857 BC858	V _{(BR)CBO}	-80 -50 -30			V	$I_{\rm C} = 10 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage (Note 6)	BC856 BC857 BC858	V _{(BR)CEO}	-65 -45 -30			V	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$
Emitter-Base Breakdown Voltage (Note 6)		V _{(BR)EBO}	-5			V	$I_{E} = 1\mu A, I_{C} = 0$
DC Current Gain (Note 6) Current Gain Group	A B C	h _{FE}	125 220 420	180 290 520	250 475 800		$V_{CE} = -5.0V, I_C = -2.0mA$
Collector-Emitter Saturation Voltage (Note 6)	V _{CE(SAT)}		-75 -250	-300 -650	mV	I _C = -10mA, I _B = -0.5mA I _C = -100mA, I _B = -5.0mA	
Base-Emitter Saturation Voltage (Note 6)	V _{BE(SAT)}		-700 -850	 -950	mV	$I_{C} = -10mA$, $I_{B} = -0.5mA$ $I_{C} = -100mA$, $I_{B} = -5.0mA$	
Base-Emitter Voltage (Note 6)	V _{BE(ON)}	-600	-650 —	-750 -820	mV	$V_{CE} = -5.0V$, $I_C = -2.0mA$ $V_{CE} = -5.0V$, $I_C = -10mA$	
Collector-Cutoff Current (Note 6)	I _{СВО} I _{СВО}			-15 -4.0	nΑ μΑ	V _{CB} = -30V V _{CB} = -30V, T _A = 150°C	
Gain Bandwidth Product			100	200		MHz	$V_{CE} = -5.0V, I_{C} = -10mA, f = 100MHz$
Collector-Base Capacitance	C _{CBO}		3	4.5	pF	V _{CB} = -10V, f = 1.0MHz	
Noise Figure					10	dB	$\label{eq:VCE} \begin{array}{l} V_{CE} = \texttt{-5.0V}, \ I_{C} = \texttt{200} \mu A, \\ R_{S} = \texttt{2} k \Omega, \ f = \texttt{1} k H z, \\ \Delta f = \texttt{200} H z \end{array}$

Notes: 6. Short duration pulse test used to minimize self-heating effect.







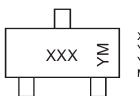


Ordering Information (Note 5 & 7)

Device	Packaging	Shipping
BC85xxW-7-F	SOT-323	3000/Tape & Reel

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXX = Product Type Marking Code (See Page 1), e.g. K3A = BC856AW YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	Κ	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b I	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6	i	7	8	9	0		Ν	D

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.